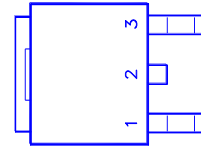
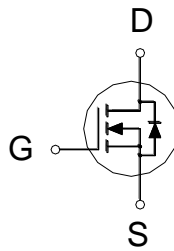




**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
200V	160mΩ	18A



- 1. GATE
- 2. DRAIN
- 3. SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	200	V
Gate-Source Voltage		$V_{GS}$	±30	V
Continuous Drain Current	$T_C = 25\text{ °C}$	$I_D$	18	A
	$T_C = 100\text{ °C}$		11	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	29	
Avalanche Current		$I_{AS}$	18	
Avalanche Energy	$L = 1.2\text{mH}$	$E_{AS}$	194	mJ
Power Dissipation	$T_C = 25\text{ °C}$	$P_D$	104	W
	$T_C = 100\text{ °C}$		41	
Junction & Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.2	°C/W

<sup>1</sup>Pulse width limited by maximum junction temperature.

**ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ °C}$ , Unless Otherwise Noted)**

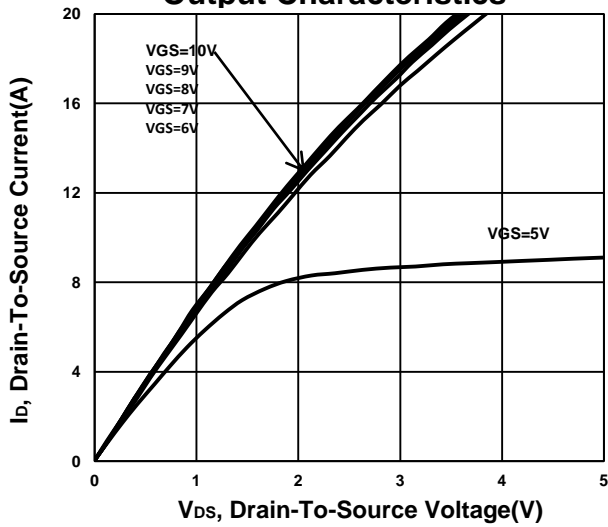
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	200			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 30V$			±100	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 200V, V_{GS} = 0V$			1	μA
		$V_{DS} = 160V, V_{GS} = 0V, T_J = 125\text{ °C}$			10	
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 9A$		130	160	mΩ
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = 10V, I_D = 9A$		17		S

DYNAMIC						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		1370		pF
Output Capacitance	$C_{oss}$			147		
Reverse Transfer Capacitance	$C_{rss}$			29		
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{DS} = 160V, V_{GS} = 10V,$ $I_D = 18A$		45		nC
Gate-Source Charge <sup>2</sup>	$Q_{gs}$			7.2		
Gate-Drain Charge <sup>2</sup>	$Q_{gd}$			21		
Turn-On Delay Time <sup>2</sup>	$t_{d(on)}$	$V_{DS} = 100V, I_D \cong 18A,$ $V_{GS} = 10V, R_G = 25\Omega$		30		nS
Rise Time <sup>2</sup>	$t_r$			260		
Turn-Off Delay Time <sup>2</sup>	$t_{d(off)}$			270		
Fall Time <sup>2</sup>	$t_f$			210		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_J = 25^\circ C$ )						
Continuous Current	$I_S$			18		A
Forward Voltage <sup>1</sup>	$V_{SD}$	$I_F = 18A, V_{GS} = 0V$		1.6		V
Reverse Recovery Time	$t_{rr}$	$I_F = 18A, di_F/dt = 100A / \mu S$		183		nS
Reverse Recovery Charge	$Q_{rr}$			1.2		uC

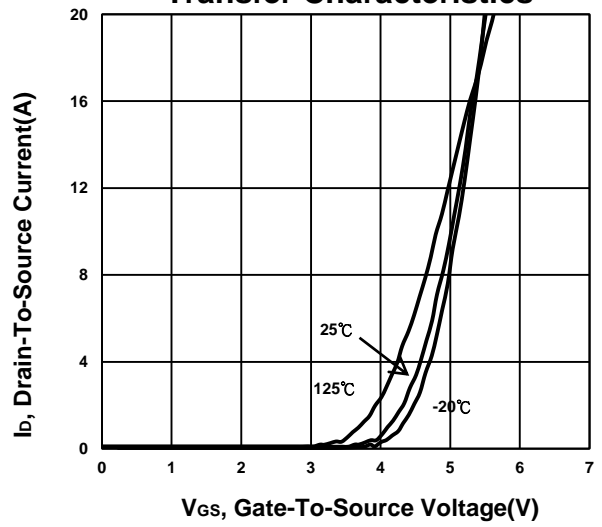
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu sec$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

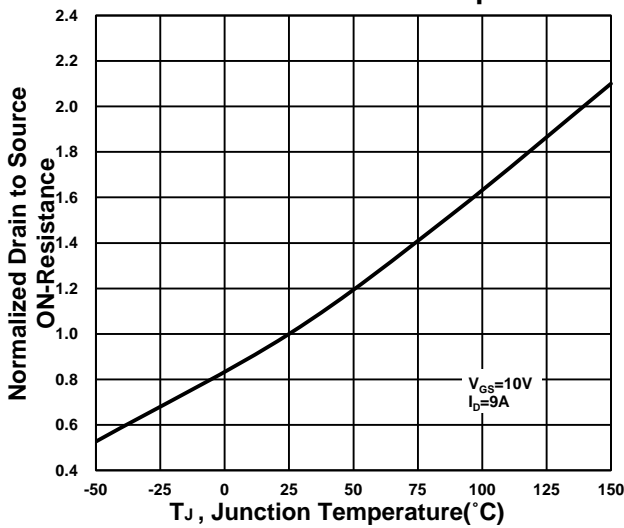
**Output Characteristics**



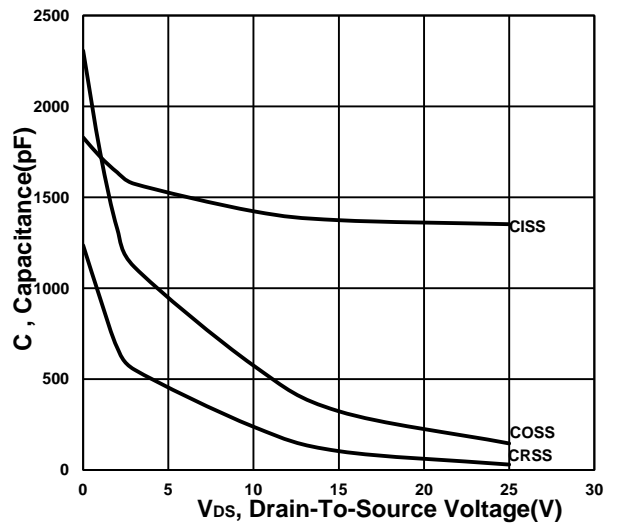
**Transfer Characteristics**



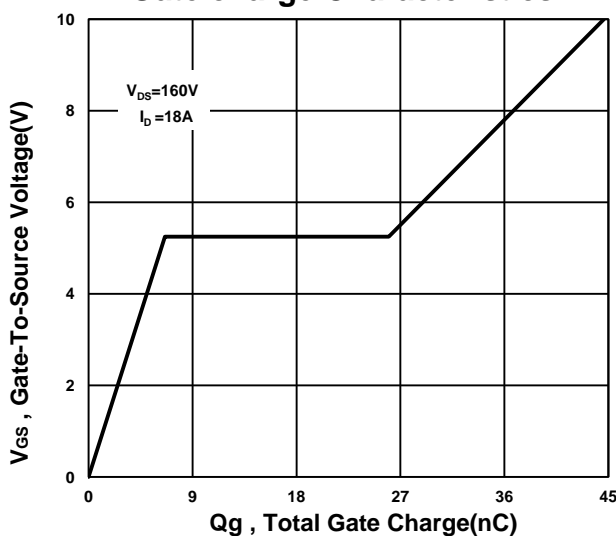
**On-Resistance VS Temperature**



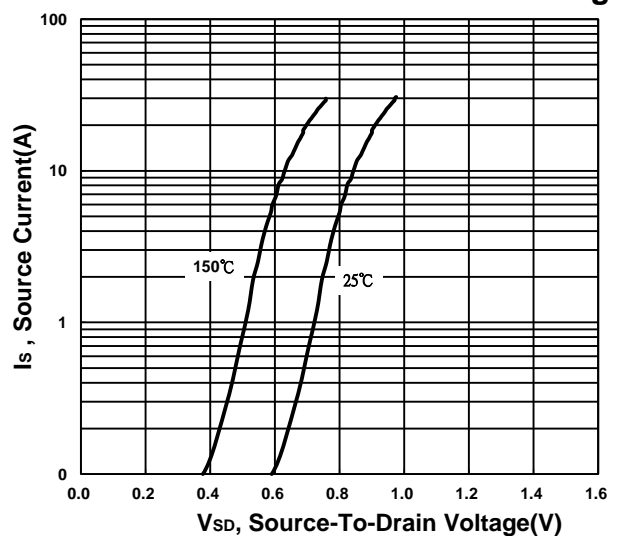
**Capacitance Characteristic**



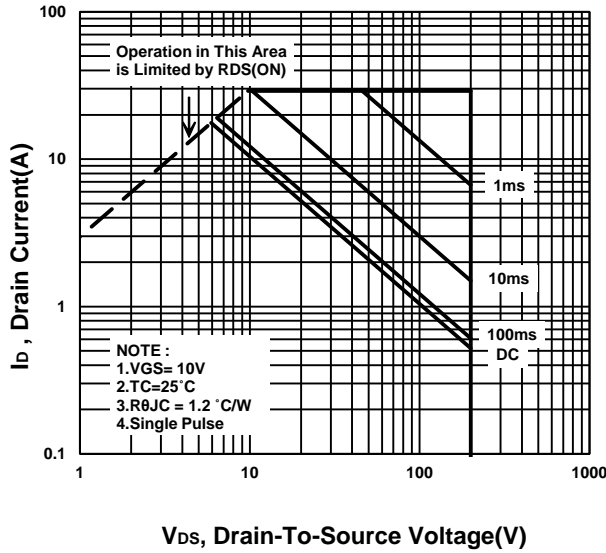
**Gate charge Characteristics**



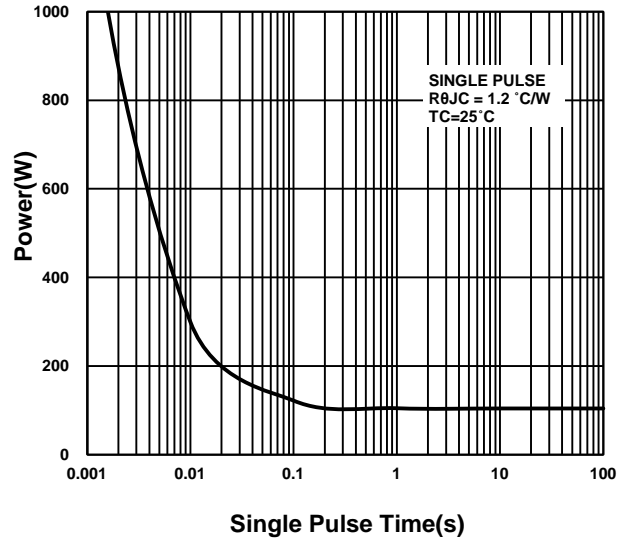
**Source-Drain Diode Forward Voltage**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

